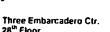
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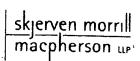
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T: 415-217-6000 F: 415-434-0646 Austin, TX San Jose, CA Newport Beach, CA



Docket No.: M-12467 US

January 24, 2002

**Box Patent Application Commissioner For Patents** Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor:

Renken, Wayne

Title:

PROCESS CONDITION SENSING WAFER AND DATA ANALYSIS SYSTEM

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This Transmittal Letter (in duplicate)

page(s) Specification (not including claims)

page(s) Claims page Abstract

Sheet(s) of Drawings page NonPublication Request

Applicant asserts entitlement to small entity status for the attached patent application

CLAIMS AS FILED (fees computed under 37 CFR 81 9(0)

CDASING AS FILED (lees computed under 37 CFR §1.9(1))									•
For Total Claims	Number <u>Filed</u> 45	-20	=	Number Extra 25	x	<u>Rate</u> \$ 9.00	_	\$ \$	Basic Fee <u>370.00</u> 225.00
		_ •			^.	\$ 7.00		J.	223.00
Independent Claims	3	-3	=	0	x	\$42.00	=	\$	0.00
Fee of for the first filing of one or more multiple dependent claims per application								\$	
Fee for Request for Extension of Time								\$	<del></del>
Please make the following charges to Deposit Account 19-2386:  Total fee for filing the patent application in the amount of  The Commissioner is hereby authorized to charge any additional fees which may be								\$	595.00
required, or credit any overpayment to Deposit Account 19-2386.									

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Respectfully submitted,

Agent

Reg. No. 46,930

Peter G. Mikhail

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